DS26LS32AC,DS26LS32C,DS26LS32M,DS26LS33M

DS26LS32AC/DS26LS32C/DS26LS32M/DS26LS33M Quad Differential Line Receivers



Literature Number: SNLS352B



DS26LS32AC/DS26LS32C/DS26LS32M/DS26LS33M Quad Differential Line Receivers

General Description

The DS26LS32 and DS26LS32A are quad differential line receivers designed to meet the RS-422, RS-423 and Federal Standards 1020 and 1030 for balanced and unbalanced digital data transmission.

The DS26LS32 and DS26LS32A have an input sensitivity of 200 mV over the input voltage range of $\pm 7V$ and the DS26LS33 have an input sensitivity of 500 mV over the input voltage range of $\pm 15V$.

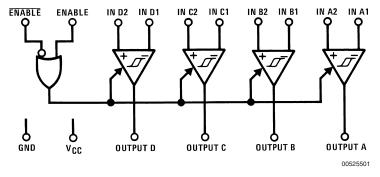
The DS26LS32A differ in function from the popular DS26LS32 and DS26LS33 in that input pull-up and pull-down resistors are included which prevent output oscillation on unused channels.

Each version provides an enable and disable function common to all four receivers and features TRI-STATE ® outputs with 8 mA sink capability. Constructed using low power Schottky processing, these devices are available over the full military and commerical operating temperature ranges.

Features

- High differential or common-mode input voltage ranges of ±7V on the DS26LS32 and DS26LS32A and ±15V on the DS26LS33
- ±0.2V sensitivity over the input voltage range on the DS26LS32 and DS26LS32A, ±0.5V sensitivity on the DS26LS33
- DS26LS32 and DS26LS32A meet all requirements of RS-422 and RS-423
- 6k minimum input impedance
- 100 mV input hysteresis on the DS26LS32 and DS26LS32A, 200 mV on the DS26LS33
- Operation from a single 5V supply
- TRI-STATE outputs, with choice of complementary output enables for receiving directly onto a data bus

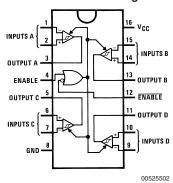
Logic Diagram



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Connection Diagrams

Dual-In-Line Package

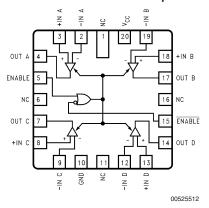


Top View

Order Number DS26LS32CM, DS26LS32CN, DS26LS32ACM, DS26LS32ACM, DS26LS33ACM or DS26LS33ACN

See NS Package Number M16A or N16E
For Complete Military Product Specifications,
refer to the appropriate SMD or MDS.
Order Number DS26LS32MJ/883, DS26LS32MW/883,
DS26LS32ME/883, DS26LS33MW/883
See NS Package Number E20A, J16A or W16A

20-Lead Ceramic Leadless Chip Carrier



Truth Table

ENABLE	ENABLE	Input	Output
0	1	X	Hi-Z
See		V _{ID} ≥ V _{TH} (Max)	1
Note Below		$V_{ID} \le V_{TH} \text{ (Min)}$	0

Hi-Z = TRI-STATE®

Note: Input conditions may be any combination not defined for ENABLE and $\overline{\text{ENABLE}}$.

Absolute Maximum Ratings (Note 3)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

	_,,
Supply Voltage	7V
Common-Mode Range	±25V
Differential Input Voltage	±25V
Enable Voltage	7V
Output Sink Current	50 mA
Maximum Power Dissipation (Note 1) at 25°C	
Cavity Package	1433 mW
Molded Dip Package	1362 mW
SO Package DS26LS32	1002 mW
DS26LS32A	1051 mW
Storage Temperature Range	−65°C to
	+165°C
Lead Temperature (Soldering, 4	

Operating Conditions

	Min	Max	Units
Supply Voltage, (V _{CC})			
DS26LS32M, DS26LS33M	4.5	5.5	V
(MIL)			
DS26LS32C	4.75	5.25	V
DS26LS32AC			
(COML)			
Temperature, (T _A)			
DS26LS32M, DS26LS33M	-55	+125	°C
(MIL)			
DS26LS32C	0	+70	°C
DS26LS32AC			
(COML)			

Note 1: Derate cavity package 9.6 mW/°C above 25°C; derate molded DIP package 10.9 mW/°C above 25°C.

Note 2: Derate SO Package 8.01 mW/°C for DS26LS32 8.41 mW/°C for DS26LS32A

260°C seconds)

Electrical Characteristics (Notes 4, 5, 6)

over the operating temperature range unless otherwise specified

Symbol	Parameter	Conditions				Тур	Max	Units
V _{TH}	Differential Input	$V_{OUT} = V_{OH}$	DS26LS32, DS26LS32A, -7V ≤ V _{CM} ≤ +7V			±0.07	0.2	V
	Voltage	or V _{OL}	DS26LS33, DS26LS33A, −15V ≤ V _{CM} +15V			±0.14	0.5	V
R _{IN}	Input Resistance	-15V ≤ V _{CM} ≤ -	+15V (One Input A	C GND)	6.0	8.5		kΩ
I _{IN}	Input Current (Under	$V_{IN} = 15V$, Oth	$er Input -15V \le V_{II}$	_N ≤ +15V			2.3	mA
	Test)	$V_{IN} = -15V, Or$	ther Input $-15V \le V$	/ _{IN} ≤ +15V			-2.8	mA
V _{OH}	Output High Voltage	$V_{CC} = MIN, \Delta V$	_{IN} = 1V,	Commercial	2.7	4.2		V
		$V_{\overline{\text{ENABLE}}} = 0.8V$	$I_{OH} = -440 \ \mu A$	Military	2.5	4.2		V
V _{OL}	Output Low Voltage	$V_{CC} = Min, \Delta V_{II}$	_N = -1V,	I _{OL} = 4 mA			0.4	V
		$V_{\overline{\text{ENABLE}}} = 0.8V$	1	I _{OL} = 8 mA			0.45	V
V_{IL}	Enable Low Voltage						0.8	V
V _{IH}	Enable High Voltage				2.0			V
V _I	Enable Clamp	$V_{CC} = Min, I_{IN} = -18 \text{ mA}$					-1.5	V
	Voltage							
Io	OFF-State (High	$V_{CC} = Max$ $V_{O} = 2.4V$				20	μΑ	
	Impedance) Output			V _O = 0.4V			-20	μΑ
	Current							
I _{IL}	Enable Low Current	$V_{IN} = 0.4V$					-0.36	mA
I _{IH}	Enable High Current	V _{IN} = 2.7V					20	μΑ
I _{sc}	Output Short-Circuit	$V_{O} = 0V, V_{CC} = Max, \Delta V_{IN} = 1V$		-15		-85	mA	
	Current							
I _{cc}	Power Supply	V _{CC} = Max, All	V _{IN} = GND,	DS26LS32, DS26LS32A		52	70	mA
	Current	Outputs Disabled		DS26LS33, DS26LS33A		57	80	mA
I ₁	Input High Current	V _{IN} = 5.5V					100	μΑ
V _{HYST}	Input Hysteresis	$T_A = 25^{\circ}C, V_{CC}$	25°C, V _{CC} = 5V, DS26LS32, DS26S32A			100		mV
		$V_{CM} = 0V$	= 0V DS26LS33, DS26LS33A			200		mV

Note 3: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 4: All currents into device pins are shown as positive, all currents out of device pins are shown as negative, all voltages are referenced to ground, unless otherwise specified. All values shown as max or min are so classified on absolute value basis.

Note 5: All typical values are $V_{CC} = 5V$, $T_A = 25$ °C.

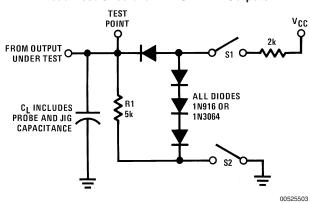
Note 6: Only one output at a time should be shorted.

Switching Characteristics V_{CC} = 5V, T_A = 25°C

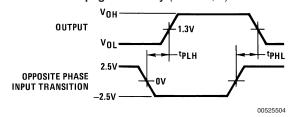
Symbol	Parameter	Conditions	DS26LS32/DS26LS33			DS26LS32A/DS26LS33A			Units
			Min	Тур	Max	Min	Тур	Max	
t _{PLH}	Input to Output	$C_L = 15 pF$		17	25		23	35	ns
t_{PHL}				17	25		23	35	ns
t _{LZ}	ENABLE to Output	$C_L = 5 pF$		20	30		15	30	ns
t_{HZ}				15	22		20	25	ns
t _{ZL}	ENABLE to Output	$C_L = 15 pF$		15	22		14	22	ns
t _{zH}				15	22		15	22	ns

AC Test Circuit and Switching Time Waveforms

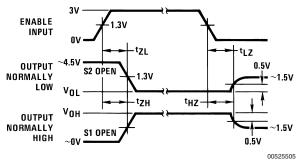
Load Test Circuit for TRI-STATE® Outputs



Propagation Delay (Notes 7, 9)



Enable and Disable Times (Notes 8, 9)



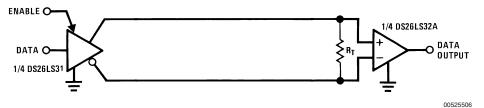
Note 7: Diagram shown for ENABLE low.

Note 8: S1 and S2 of load circuit are closed except where shown.

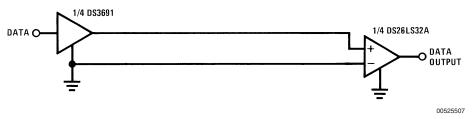
Note 9: Pulse generator for all pulses: Rate = 1.0 MHz; $Z_O = 50\Omega$; $t_f \le 6$ ns; $t_f \le 6.0$ ns.

Typical Applications

Two-Wire Balanced Interface — RS-422

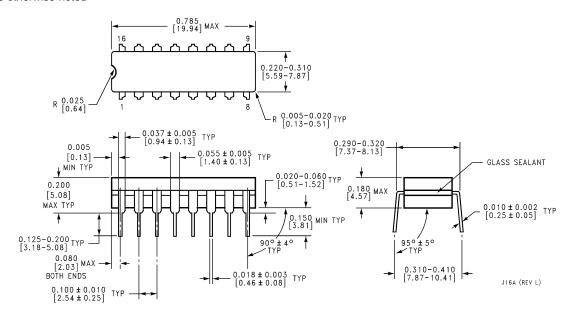


Single Wire with Driver Ground Reference—RS-423

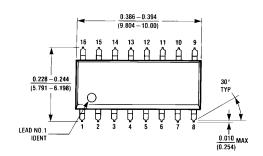


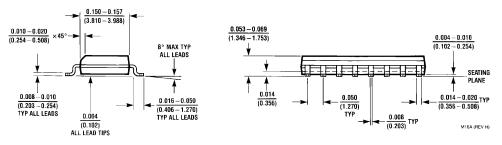
Physical Dimensions inches (millimeters)

unless otherwise noted



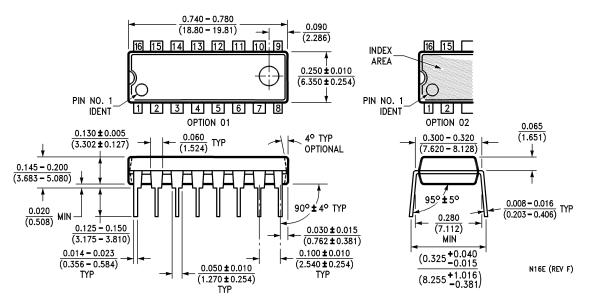
Ceramic Dual-In-Line Package (J)
Order Number DS26LS32MJ/883 or DS26LS33MJ/883
NS Package Number J16A



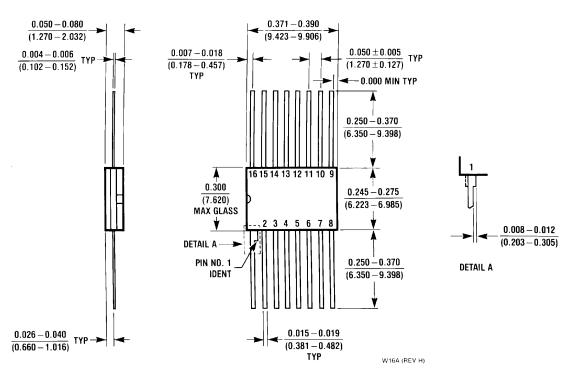


Small Outline Package (M)
Order Number DS26LS32CM or DS26LS32ACM
NS Package Number M16A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

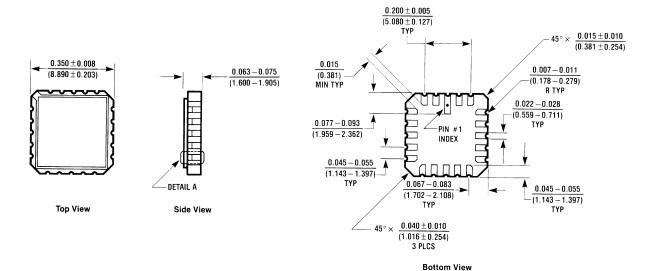


Molded Dual-In-Line Package (N)
Order Number DS26LS32CN or DS26LS32ACN
NS Package Number N16E



16 Lead Ceramic Flatpak (W)
Order Number DS26LS32MW/883 or DS26LS33MW/883
NS Package Number W16A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



0.003 (0.076) MIN TYP 0.022 (0.559) MAX TYP Detail A

E20A (REV D)

20 Lead Ceramic Leadless Chip Carrier (E) Order Number DS26LS32ME/883 NS Package Number E20A

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